AUTOMOTIVE GRADE

Available

COMPLIANT

HALOGEN

FREE



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## Vishay General Semiconductor

# **High Current Density Surface-Mount** TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.43 \text{ V}$  at  $I_F = 6 \text{ A}$ 



## **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	12.0 A			
V <sub>RRM</sub>	60 V			
I <sub>FSM</sub>	200 A			
$V_F$ at $I_F = 12.0$ A $(T_J = 125  ^{\circ}C)$	0.52 V			
T <sub>J</sub> max.	175 °C			
Package	SMPC (TO-277A)			
Circuit configuration	Single			

### **FEATURES**

- Very low profile typical height of 1.1 mm
- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code; base P/NHM3
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

## **TYPICAL APPLICATIONS**

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

### **MECHANICAL DATA**

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V12PM63	UNIT	
Device marking code		12M63		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	60	V	
Maximum average forward rectified current (fig. 1)	I <sub>F</sub> <sup>(1)</sup>	12.0	^	
	I <sub>F</sub> <sup>(2)</sup>	4.6	A	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	200	А	
Operating junction temperature range	T <sub>J</sub> <sup>(3)</sup>	-40 to +175	°C	
Storage temperature range	T <sub>STG</sub>	-55 to +175	°C	

## Notes

- (1) Mounted on 30 mm x 30 mm pad areas aluminum PCB
- (2) Free air, mounted on recommended copper pad area
- (3) The heat generated must be less than the thermal conductivity from junction-to-ambient: dPp/dTJ <1/ ReJA



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 6.0 A	T <sub>J</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.52	-	V
	I <sub>F</sub> = 12.0 A			0.58	0.65	
	I <sub>F</sub> = 6.0 A	- T <sub>J</sub> = 125 °C		0.43	-	
	I <sub>F</sub> = 12.0 A			0.52	0.58	
Reverse current	V <sub>R</sub> = 60 V	T <sub>J</sub> = 25 °C T <sub>J</sub> = 125 °C		-	0.03	mA
	v <sub>R</sub> = 60 v			2	6.0	
Typical junction capacitance	4.0 V, 1 MHz		CJ	2400	-	pF

#### Notes

 $^{(1)}$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER SYMBOL V12PM63				
Typical thermal resistance	R <sub>θJA</sub> (1)(2)	75	°C/W	
Typical thermal resistance	R <sub>0JM</sub> (3)	4		

### Notes

 $^{(1)}$  The heat generated must be less than the thermal conductivity from junction to ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

<sup>(2)</sup> Free air mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient

 $^{(3)}$  Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance  $R_{\theta JM}$  - junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V12PM63-M3/H	0.10	Н	1500	7" diameter plastic tape and reel	
V12PM63-M3/I	0.10	1	6500	13" diameter plastic tape and reel	
V12PM63HM3/H (1)	0.10	Н	1500	7" diameter plastic tape and reel	
V12PM63HM3/I (1)	0.10	I	6500	13" diameter plastic tape and reel	

## Note

(1) AEC-Q101 qualified



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## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

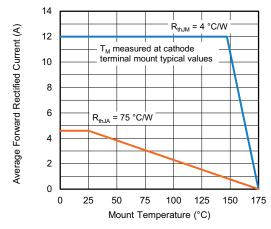


Fig. 1 - Forward Current Derating Curve

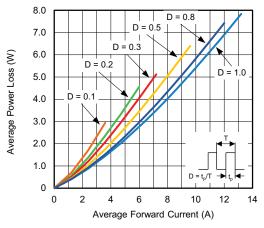


Fig. 2 - Forward Power Loss Characteristics

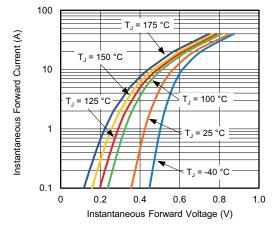


Fig. 3 - Typical Instantaneous Forward Characteristics

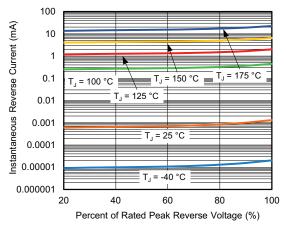


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

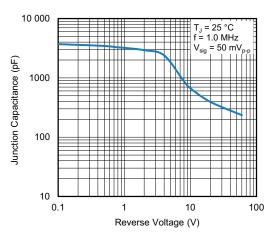


Fig. 5 - Typical Junction Capacitance

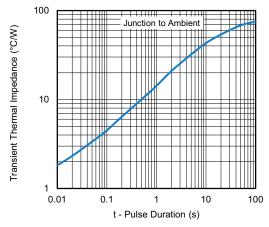
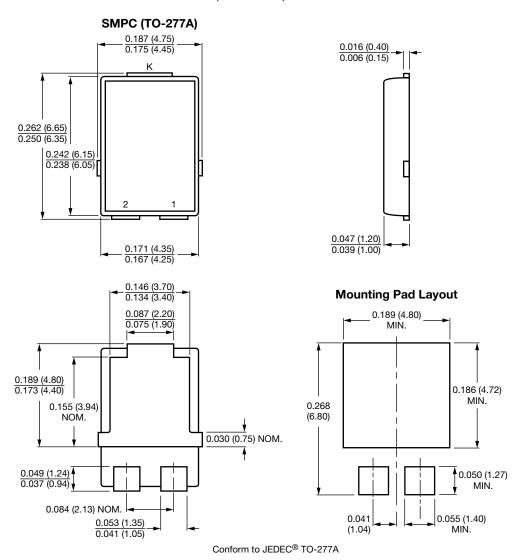


Fig. 6 - Typical Transient Thermal Impedance



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## **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)





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